

05-19-2006

Form PTO-1595 (Rev. 07/05)
OMB No. 0651-0027 (exp. 6/30/2008)U.S. DEPARTMENT OF COMMERCE
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5/16/06

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PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):Thomas HECHT (02/13/2006), Henry
BERNHARDT (01/18/2006), and Christian
KAPTEYN (03/04/2006)Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No**2. Name and address of receiving party(ies)**Name: INFINEON TECHNOLOGIES AG

Internal Address: _____

Street Address: _____

St.-Martin-Str. 53

City: München

State: _____

Country: Germany Zip: 81669Additional name(s) & address(es) attached? ☐ Yes ☒ No**3. Nature of conveyance/Execution Date(s):**

Execution Date(s): in parentheses after inventor name

☒ Assignment ☐ Merger ☐ Change of Name☐ Security Agreement ☐ Joint Research Agreement☐ Government Interest Assignment☐ Executive Order 9424, Confirmatory License☐ Other _____**4. Application or patent number(s):**

A. Patent Application No.(s)

11/319,793

☐ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No**5. Name and address to whom correspondence concerning document should be mailed:**Name: Kevin R. Spivak
MORRISON & FOERSTER LLP

Internal Address: Atty. Dkt.: 543822021700

Street Address: 1650 Tysons Blvd, Suite 300

City: McLeanState: VA Zip: 22102Phone Number: (703) 760-7762Fax Number: (703) 760-7777Email Address: KSpivak@mofo.com**6. Total number of applications and patents involved:**

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00☐ Authorized to be charged by credit card☒ Authorized to be charged to deposit account☐ Enclosed☐ None required (government interest not affecting title)**8. Payment Information**

a. Credit Card Last 4 Numbers _____

Expiration Date _____

b. Deposit Account Number 03-1952Authorized User Name Kevin R. Spivak**9. Signature:**

Signature

May 16, 2006

Date

Kevin R. Spivak - 43, 448

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

7

05/16/2006 DBYRME 00000094 031952 11319793

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va-162828

PATENT
REEL: 017896 FRAME: 0816

1.157 3045-615

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MORRISON & FOERSTER LLP

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, the undersigned hereby assign(s), transfer(s) and set(s) over to:

Infineon Technologies AG
St.-Martin-Str. 53
81669 München
GERMANY

(hereinafter designated as the "ASSIGNEE"), its successors and assigns, the entire right, title, and interest for the United States in the invention, and all applications for patent and any Letters Patent which may be granted therefor, including said application, and all United States Letters Patent which may be granted thereof, and all divisions, reissues, continuations and extensions thereof, the said interest being the entire ownership of said Letters Patent when granted to be held by said ASSIGNEE, its successors, assigns or their legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been and enjoyed by Assignor(s) if this assignment had not been made, the application being known by the title:

**METHOD FOR FABRICATING AN INTEGRATED CIRCUIT ON A
SEMICONDUCTOR SUBSTRATE**

Attorney Docket No.: 543822021700

for which the undersigned has/have executed an application for patent in the United States of America on the same day herewith. Where this instrument is not filed concurrently with the application, the following identifying information may be added after execution:

Serial No.: 11/319,793

Filing Date: December 29, 2005

1. The undersigned hereby agree(s) to sign and execute any further documents and instruments which may be necessary, lawful and proper in the prosecution of said above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reexamination or reissue application or in any amendments, extension of interference proceedings, or otherwise to secure the title thereto to the ASSIGNEE.

543822021700

2. The undersigned agree(s) to execute all papers and documents and perform any act which may be necessary in connection with claims or provisions of the International Convention for Protection of Industrial Property of similar agreements.

3. The undersigned agree(s) to perform all affirmative acts which may be necessary to obtain a grant of a valid United States patent to the ASSIGNEE.

4. The undersigned hereby authorize(s) and request(s) the Commissioner of Patents in the United States to issue any and all Letters Patent resulting from said application or any division or divisions or continuing applications thereof to the said ASSIGNEE.

5. The undersigned hereby grant(s) to the firm of Morrison & Foerster LLP the power to insert on this assignment any further identification which may be necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

IN WITNESS WHEREBY, executed by the undersigned on the date(s) opposite the undersigned name(s).

X 13.02.2006
Date

X Thomas Hecht
Typed Name: Thomas HECHT

Date

Typed Name: Henry BERNILARDT

Date

Typed Name: Christian KAPTEYN

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01/18/06
Date

X Henry B.hardt
Typed Name: Henry BERNHARDT

Date

Typed Name: Christian KAPTEYN

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Date

Typed Name: Thomas HECHT

Date

Typed Name: Henry BERNHARDT

03-04-2006

Date

Typed Name: Christian KAPTEYN